

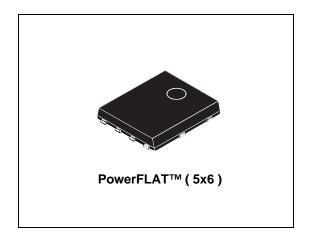
STL100N1VH5

N-channel 12 V, 0.0022 Ω, 25 A PowerFLAT™ (5x6) STripFET™ V Power MOSFET

Features

Order code	V _{DSS}	R _{DS(on)} max.	I _D
STL100N1VH5	12 V	<0.003 Ω	25 A ⁽¹⁾

- 1. The value is rated according $R_{thj\text{-pcb}}$
- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses



Application

Switching applications

Description

This device is a 12 V N-channel STripFET™V Power MOSFET which has been designed to achieve very low on-state resistance providing also one of the best-in-class figure of merit (FOM).

Figure 1. Pin-out configuration

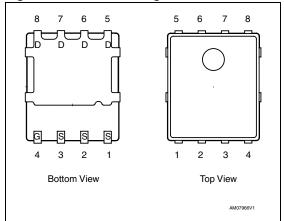


Table 1. Device summary

Order code	Marking	Package	Packaging
STL100N1VH5	100N1VH5	PowerFLAT™ (5x6)	Tape and reel

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STL100N1VH5 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	12	V
V _{GS}	Gate-source voltage	± 8	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	100	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	62.5	Α
I _D ⁽²⁾	Drain current (continuous) at T _C = 25 °C	25	Α
I _D ⁽²⁾	Drain current (continuous) at T _C =100°C	15.6	Α
I _{DM} ⁽³⁾	Drain current (pulsed)	100	Α
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25°C	60	W
P _{TOT} (2)	Total dissipation at T _C = 25°C	4	W
	Derating factor	0.03	W/°C
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

^{1.} The value is rated according $R_{\mbox{\scriptsize thj-c}}$

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case (Drain) (steady state)	2.08	°C/W
R _{thj-pcb} (1)	Thermal resistance junction-ambient	31.3	°C/W

^{1.} When mounted on FR-4 board of 1inch 2 , 2oz Cu, t < 10 sec

Table 4. Avalanche data

Symbol	Parameter	Value	Unit
I _{AV}	Not-repetitive avalanche current (pulse width limited by Tj Max)	12.5	Α
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AV}$, $V_{DD} = 12$ V)	300	mJ

^{2.} The value is rated according $R_{\mbox{\scriptsize thj-pcb}}$

^{3.} Pulse width limited by safe operating area

Electrical characteristics STL100N1VH5

2 Electrical characteristics

 $(T_{CASE} = 25 \, ^{\circ}C \text{ unless otherwise specified})$

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	12			٧
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max rating, V_{DS} = max rating @125 °C			1 10	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 8 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.5			V
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 4.5 V, I_{D} = 12.5 A V_{GS} = 2.5 V, I_{D} = 12.5 A		0.0022 0.0032	0.003 0.004	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =10 V, f=1 MHz, V _{GS} =0	-	2085 949 240	-	pF pF pF
$egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =6 V, I_{D} = 12.5 A V_{GS} =4.5 V Figure 14	-	26.5 5.2 4.8	-	nC nC nC



Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{d(on)}$ t_{r} $t_{d(off)}$ t_{f}	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =6 V, I_{D} = 12.5 A, R_{G} =4.7 Ω , V_{GS} =4.5 V Figure 13	-	14.4 31.6 50 16	-	ns ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current		-		25	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		100	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 25 A, V _{GS} =0	-		1.1	٧
t _{rr}	Reverse recovery time	I _{SD} = 25 A,		49		ns
Q_{rr}	Reverse recovery charge	di/dt = 100 A/μs,	-	54		nC
I _{RRM}	Reverse recovery current	V _{DD} =10 V, Tj=150 °C		2.2		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration= 300 µs, duty cycle 1.5%

Electrical characteristics STL100N1VH5

Electrical characteristics (curves) 2.1

Figure 2.

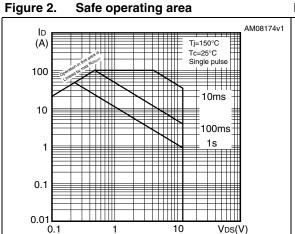


Figure 3. Thermal impedance

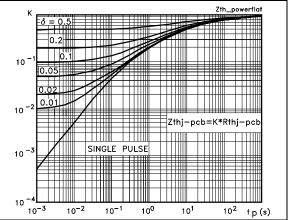


Figure 4. **Output characteristics**

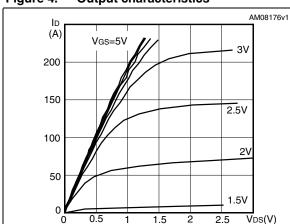


Figure 5. **Transfer characteristics**

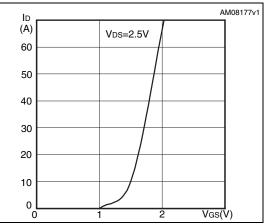
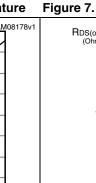
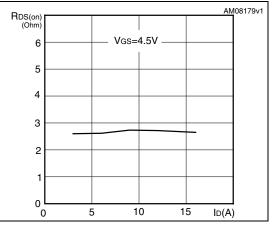


Figure 6. Normalized B_{VDSS} vs temperature



Static drain-source on resistance



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BVDSS (norm)

1.08

1.04

1.00

0.96

-50 -25

0 25 75 100

50

T_J(°C)

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

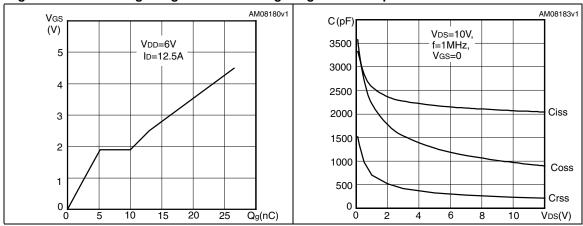


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

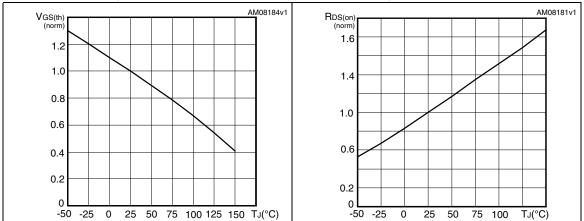
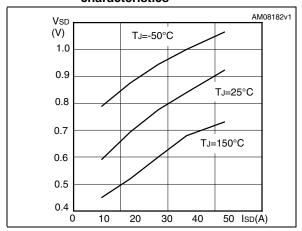


Figure 12. Source-drain diode forward characteristics



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Test circuits STL100N1VH5

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

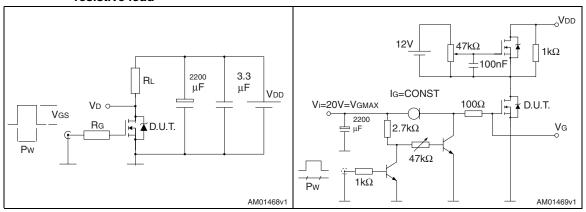


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

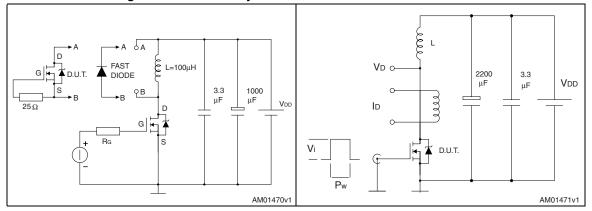
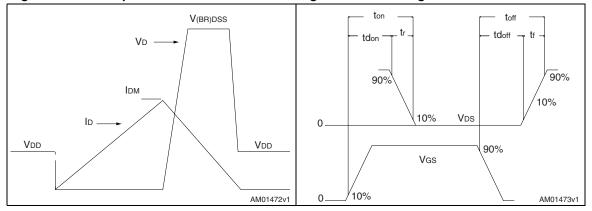


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

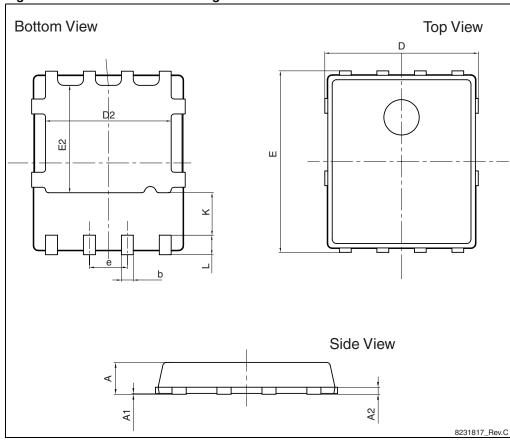
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Table 9. PowerFLAT 5x6 mechanical data

Dim.	mm		
Dilli.	Min.	Тур.	Max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D		5.20	
E		6.15	
D2	4.11		4.31
E2	3.50		3.70
е		1.27	
e1		0.65	
L	0.715		1.015
K	1.05		1.35

Figure 19. PowerFLAT 5x6 drawing



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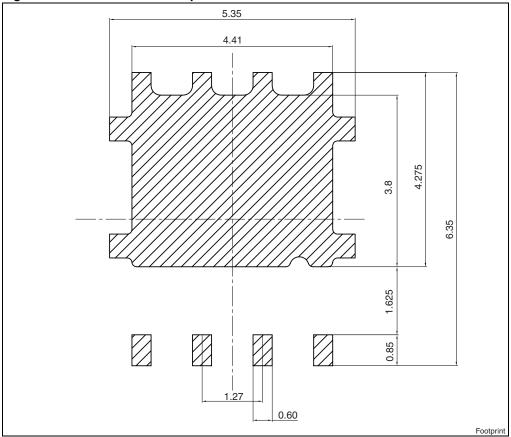


Figure 20. Recommended footprint

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Revision history STL100N1VH5

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
10-Mar-2011	1	First release.

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